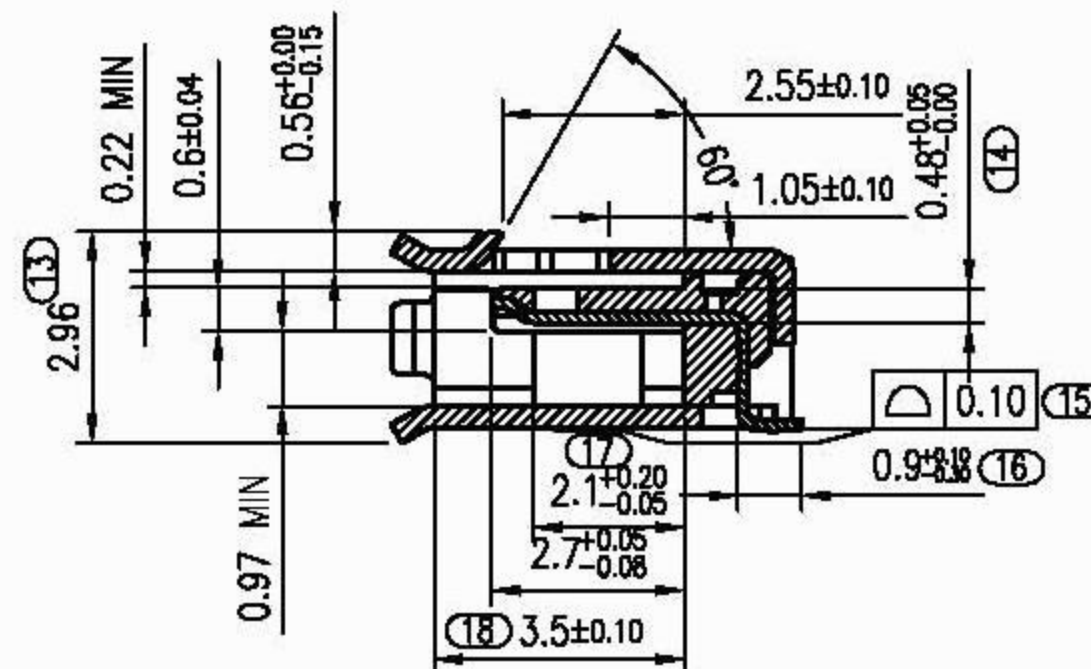
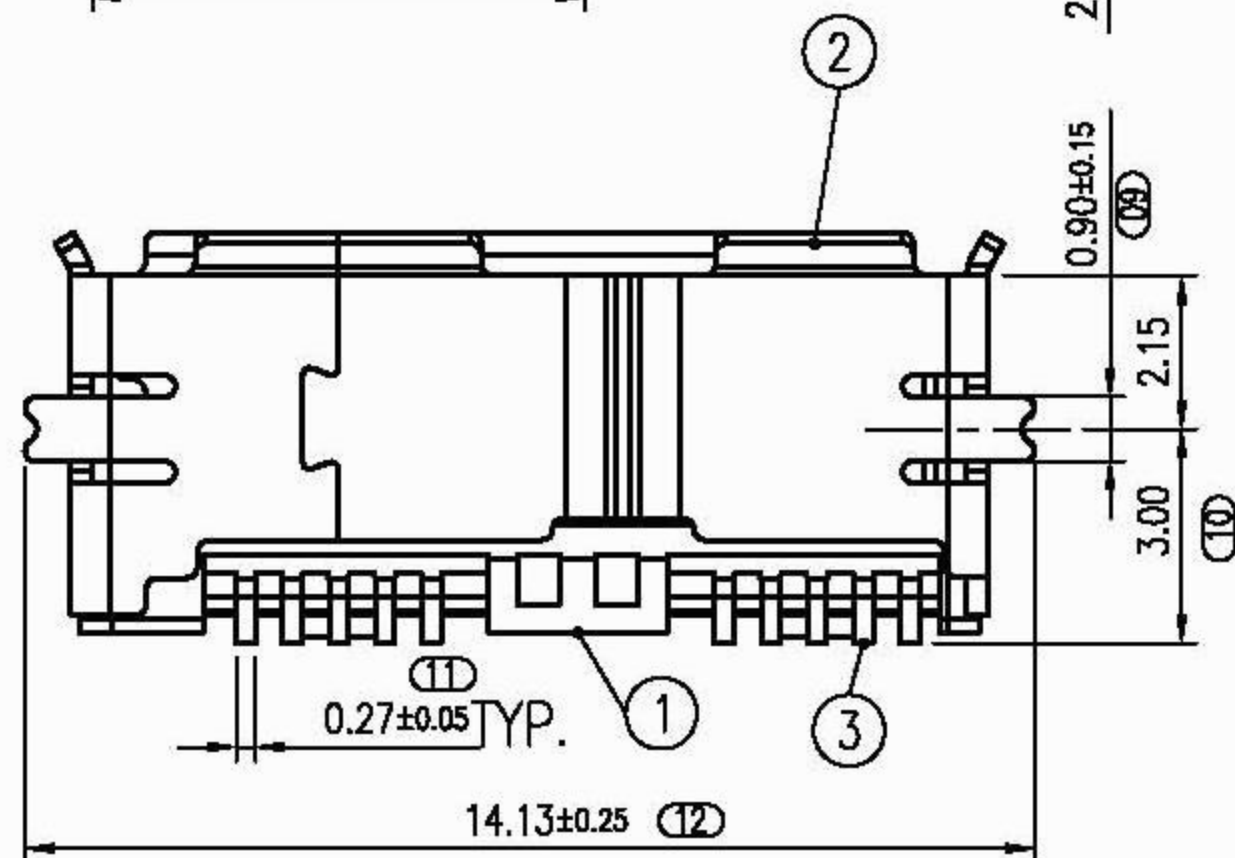
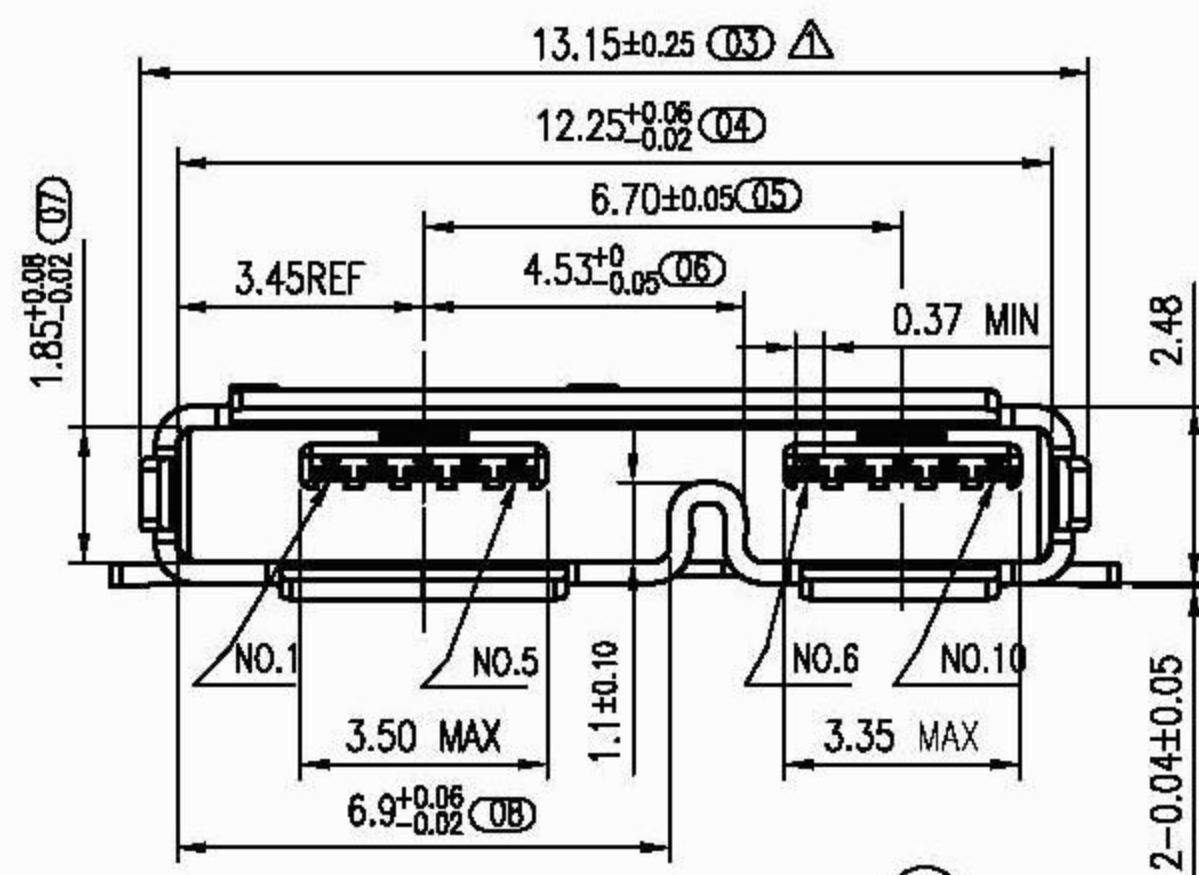
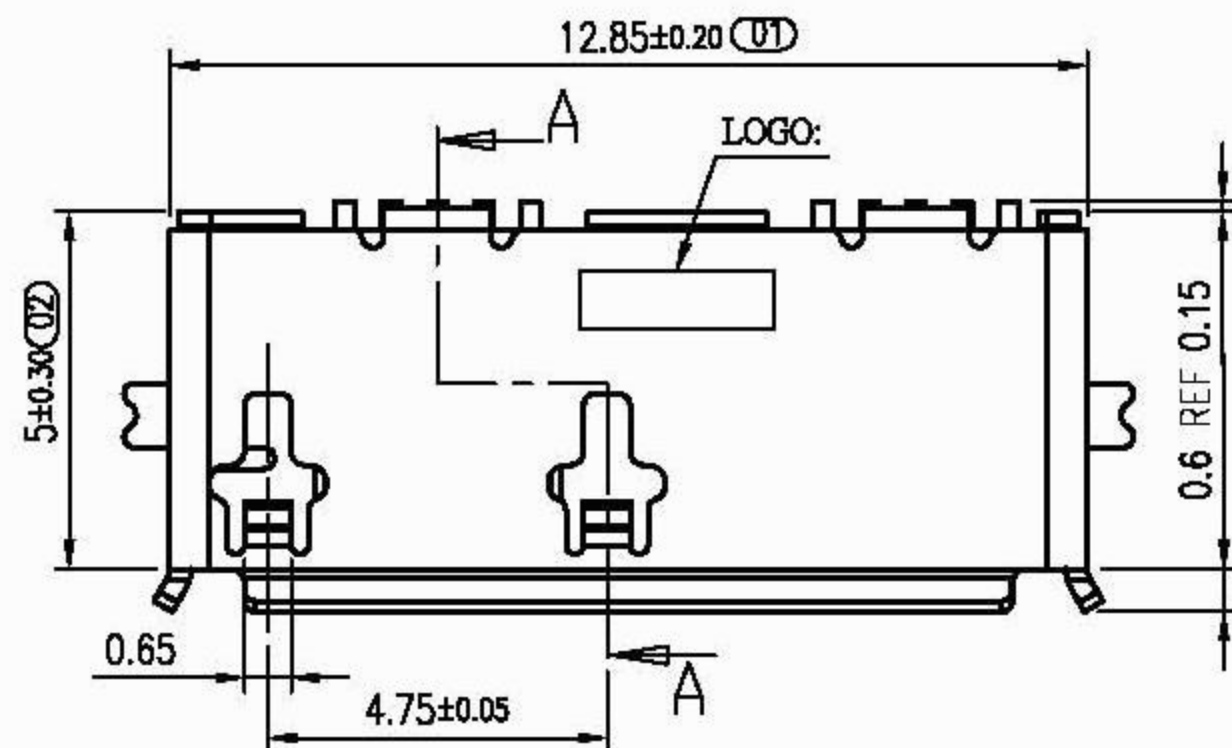
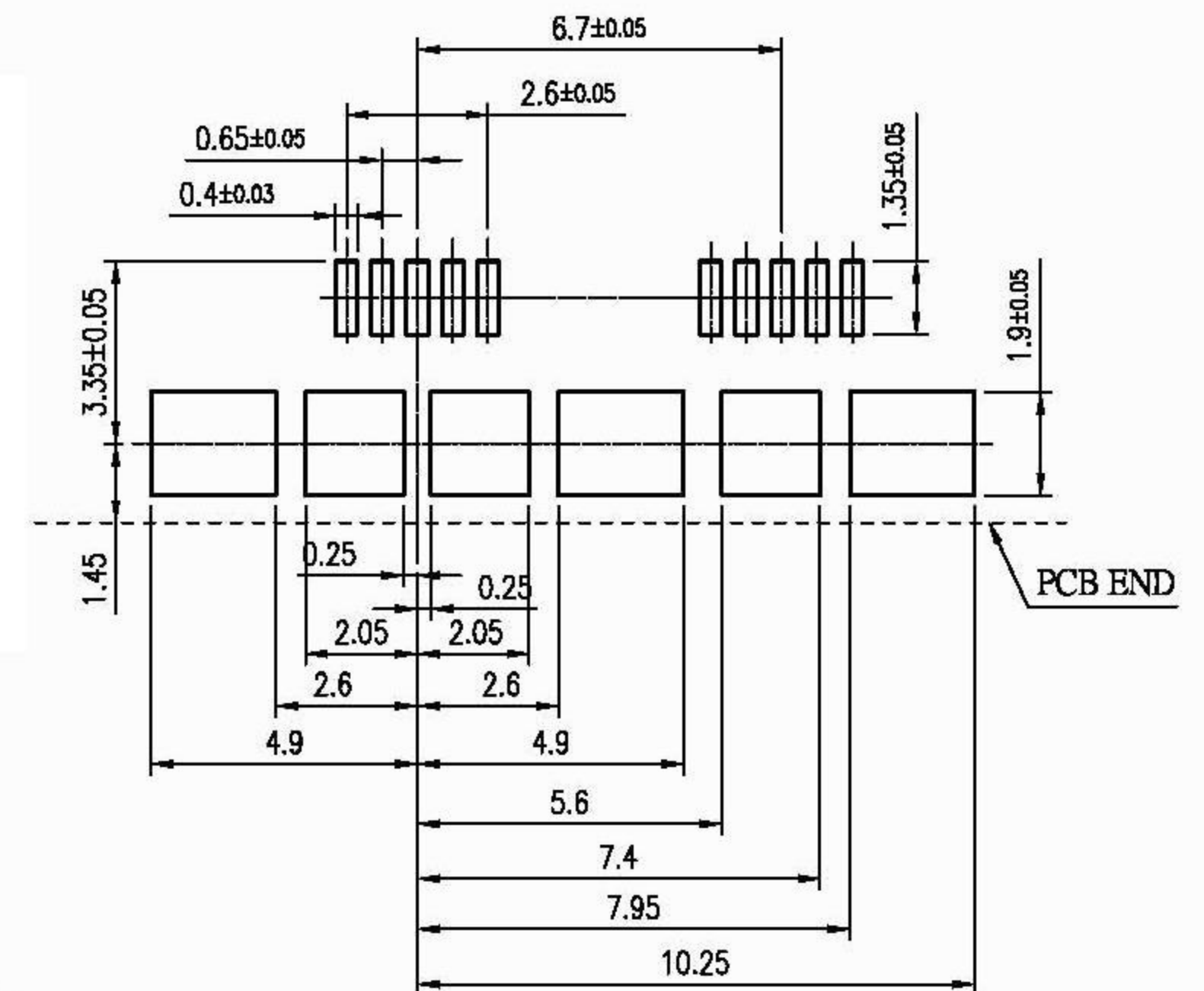




NOTES:

1. INSULATOR: LCP . COLOR-BLACK
2. USB CONTACT: BRASS, 0.15mm THICKNESS, GOLD PLATED ON CONTACT AREA, GOLD FLASH OR 50 U" TIN PLATED ON SOLDER TAIL, 80 U" MIN. NICKEL UNDER PLATED OVERALL.
3. SHELL: STAINLESS STEEL ,0.3 THICKNESS, GOLD FLASH OR 40U" NICKEL PLATED ON THE SOLDERING TAB.



RECOMMENDED PCB LAYOUT

Pin Assignments			
Shell		Shield	
10		MicB_SSRX+	
9		MicB_SSRX-	
8		GND_DRAIN	
7		MicB_SSTX+	
6		MicB_SSTX-	
5		GND	
4		ID	
3	CONTACT	3	D+
2	SHELL	2	D-
1	HOUSING	1	VBUS
ITEM	DESCRIPTION	PIN NO.	SIGNAL NAME

3	CONTACT	3	D+
2	SHELL	2	D-
1	HOUSING	1	VBUS
ITEM	DESCRIPTION	PIN NO.	SIGNAL NAME

TOLERANCE:		UNIT	L&X 深圳市连欣科技有限公司			
X. ± 0.30	X.* ± 1°	MM				
.X ± 0.20	.X.* ± 1°	SHEET				
.XX ± 0.15	.XX.* ± 1.0°	1/1	DRAW:	Andy	2009.07.22	P/N: XDBF-0830-0506
.XXX ± 0.05		SCALE	DESIGN:			ITEM: USB 3.0 Micro_AB RECEPTACLE, R/A SMT TYPE
		1:1	CHECK:			DRW NO: C-MUB3A-02XXX30X
		REV: v1.0	APPR:			

△	ECN1012001	外形长度变更	陈彩敏	2010.12.25
LTR	ECN NO	REVISION	RECORD	DATE